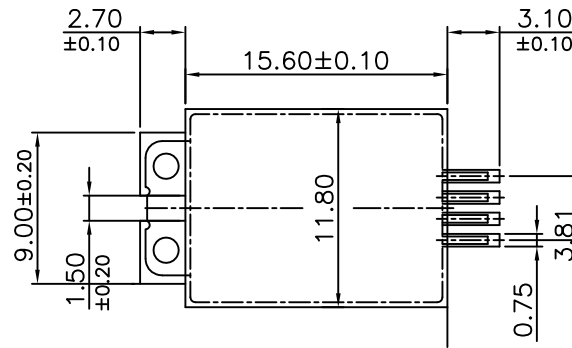
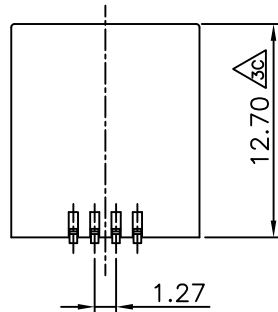
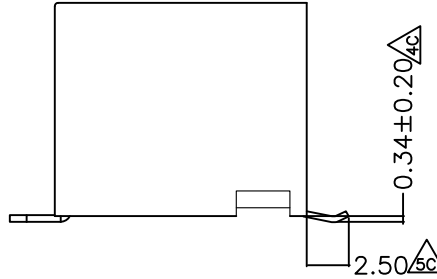
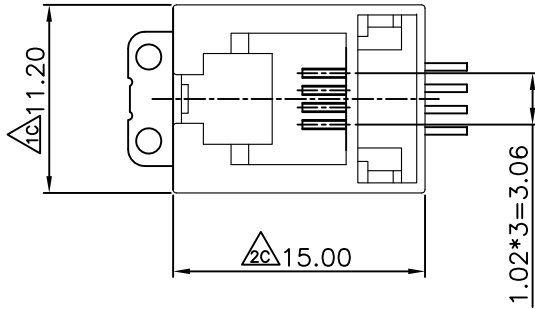


RoHS compliant



PCB LAYOUT/TOP VIEW

#### NOTES

##### MATERIAL

1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC  
FLAMMABILITY RATING UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
3. PLATING : GOLD LATING OVER NICKEL IN CONTACT  
TIN PLATING OVER NICKEL IN SOLDER AREA.  
: FU", 3U", 6U", 15U", 30", 50".

##### ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

##### MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

##### ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
  2. OPERATION : -20°C TO +75°C.
  3. IR Reflow Soldering Tempature:255° C To **265°C(5~10 Seconds)**.
- Mates With Modular Plug Conforming To FCC Part 68, Subpart F.

P/N:RJ52S-4411-045051X

RJ11 180° SMT SERIES PCB JACK

POSITIONS (金針位置):

4-POSITIONS (4P)

CONTACTS (金針根數):

4-CONTACTS (4C)

PORTS (窗口):

1-1X1

SHIELD (屏蔽壳):

0-Without SHIELD (无屏蔽壳)

PEG/TAB (边定位脚):

4-Without Housing PEG (无定位柱)

GOLD PLATING (鍍金厚度):

1-1U"; 3-30"; 5-60";

6-15U"; 7-30U"; 8-50U";

PACKING TYPE (包装):

1-REEL (卷带包装)

2-PVC TRAY (盘装)

COLOR (颜色):

1-BLACK (黑色)

PLASTIC (塑料):

4-LCP; 5-PA9T

LED STYLE (LED 颜色类型):

0-Without LED (无LED)

GENERAL TOLERANCE

DRAWN

Gene Li

2017/07/13

.X ±0.35 X.° ±2°

CHECKE

JK

.XX ±0.25 X.° ±1°

APPROVE

.XXX ±0.15 .XX° ±0.5°

PROJECT

UNIT mm SCALE 1:1 SHEET 1/1

REV A0

ECN NO

DESCRIPTION

DATE

SIGNATURE

NEW DESIGN

2017/07/13

REVISION

DESCRIPTION

DATE

SIGNATURE

PROJECT

UNIT mm SCALE 1:1 SHEET 1/1

REV A0

ECN NO

DESCRIPTION

DATE

SIGNATURE

NEW DESIGN

2017/07/13

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DATE

SIGNATURE

**X-SHUN** 东莞市祥舜电子科技有限公司  
DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD

PART NO. RJ52S-4411-045051X

TITLE: RJ11 4P4C 180° SMT H=12.7MM PCB JACK

REV A0 DRAWING NO. RJ52S-44